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INTERNATIONAL STANDARD



**Field device integration (FDI) –
Part 6: ~~FDI~~ Technology Mapping**

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ELECTROTECHNICAL
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CONTENTS

FOREWORD.....	4
INTRODUCTION.....	2
1 Scope.....	8
2 Normative references	8
3 Terms, definitions, abbreviated terms, acronyms symbols and conventions	9
3.1 Terms and definitions.....	9
3.2 Abbreviated terms and acronyms	9
3.3 Symbols.....	9
3.4 Conventions.....	10
4 Technical concepts.....	10
4.1 General.....	10
4.1.1 Overview	10
4.1.2 Platforms	10
4.1.3 FDI Type Library.....	10
4.2 UIP representation.....	12
4.3 UIP executable representation	12
4.4 UIP executable compatibility rules	12
4.5 Allowed .NET Common Language Run-time versions.....	13
4.5.1 General	13
4.5.2 CLR compatibility strategy	13
4.5.3 How to identify the .NET target platform of a UIP	14
4.6 Installing UIP Deployment.....	14
4.7 UIP Lifecycle.....	15
4.7.1 General	15
4.7.2 UIP Assembly activation steps.....	15
4.7.3 UIP Assembly deactivation steps	17
4.8 Interaction between an FDI Client and a UIP.....	18
4.8.1 Handling of standard UI elements	18
4.8.2 Non-blocking service execution	18
4.8.3 Blocking service execution.....	19
4.8.4 Cancel service execution	20
4.8.5 Threading	21
4.8.6 Timeout	21
4.8.7 Exception handling	22
4.8.8 Type safe interfaces	23
4.8.9 Globalization and localization	23
4.8.10 WPF Control handling.....	23
4.8.11 Win Form handling.....	23
4.9 Security	23
4.9.1 General	23
4.9.2 Access permissions	24
4.9.3 Code identity concept	24
5 Interface definition.....	26
Bibliography.....

Figure 1 – FDI Type Library structure..... 11

Figure 2 – .NET surrogate process 13

Figure 3 – Identification of Run-time Version..... 14

Figure 4 – IAsyncPattern based asynchronous service execution example..... 19

Figure 5 – Blocking service execution example using IAsyncResult based pattern 20

Figure 6 – Cancel service processing sequence example 20

Figure 7 – Exception source 22

Table 1 – Technology edition reference 10

Table 2 – Base Property Services 26

Table 3 – Device Model Services 27

Table 4 – Access Control Services..... 27

Table 5 – Direct Access Services..... 27

Table 6 – Hosting Services 27

Table 7 – UIP Services 29

Table 8 – Base Data Types..... 30

Table 9 – Special Types 30

INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIELD DEVICE INTEGRATION (FDI) –

Part 6: ~~FDI~~ Technology Mapping

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International Standard IEC 62769-6 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This second edition cancels and replaces the first edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) redesign of the security concept for UIP execution.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
65E/763/FDIS	65E/773/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

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- ~~b) Method and device for accessing a functional module of automation system, see Patent Family EP2182418;~~
- ~~c) Methods and apparatus to reduce memory requirements for process control system software applications, see Patent Family US2013232186;~~
- ~~d) Extensible Device Object Model, see Patent Family US12/893,680.~~

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- Part 1: Overview
- Part 2: FDI Client
- Part 3: FDI Server
- Part 4: FDI Packages
- Part 5: FDI Information Model
- Part 6: FDI Technology Mapping
- Part 7: FDI Communication Devices

- Part 100: Profiles – Generic Protocol Extensions
- Part 101-1: Profiles – Foundation Fieldbus H1
- Part 101-2: Profiles – Foundation Fieldbus HSE
- Part 103-1: Profiles – PROFIBUS
- Part 103-4: Profiles – PROFINET
- Part 109-1: Profiles – HART and WirelessHART
- Part 115-2: Profiles – Protocol-specific Definitions for Modbus RTU
- Part 150-1: Profiles – ISA 100.11a

FIELD DEVICE INTEGRATION (FDI) –

Part 6: ~~FDI~~ Technology Mapping

1 Scope

This part of IEC 62769 specifies the technology mapping for the concepts described in the Field Device Integration (FDI) standard. The technology mapping focuses on implementation regarding the components FDI Client and User Interface Plug-in (UIP) that are specific only to the WORKSTATION platform/.NET as defined in IEC 62769-4:~~2015, Annex E~~.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61804 (all parts), *Function blocks (FB) for process control and Electronic Device Description Language (EDDL)*

IEC 62769-1, *Field Device Integration (FDI) – Part 1: Overview*

IEC 62769-2, *Field Device Integration (FDI) – Part 2: FDI Client*

IEC 62769-4, *Field Device Integration (FDI) – Part 4: FDI Packages*

IEC 62541 (all parts), *OPC Unified Architecture*

~~IEC 61804 (all parts), *Function blocks (FB) for process control*~~

~~IEC 62769-1, *Field Device Integration (FDI) – Part 1: Overview*~~

~~NOTE – IEC 62769-1 is technically identical to FDI-2021.~~

~~IEC 62769-2, *Field Device Integration (FDI) – Part 2: FDI Client*~~

~~NOTE 1 – IEC 62769-2 is technically identical to FDI-2022.~~

~~NOTE 2 – IEC 62769-2 is technically identical to FDI-2023.~~

~~IEC 62769-4:2015, *Field Device Integration (FDI) – Part 4: FDI Packages*~~

~~NOTE – IEC 62769-4 is technically identical to FDI-2024.~~

~~IEC 62769-5, *Field Device Integration (FDI) – Part 5: FDI Information Model*~~

~~NOTE 1 – IEC 62769-5 is technically identical to FDI-2025.~~

~~NOTE 2 – IEC 62769-5 is technically identical to FDI-2027.~~

ISO/IEC 19505-1, *Information technology – Object Management Group Unified Modeling Language (OMG UML) – Part 1: Infrastructure*

ISO/IEC 29500, (all parts) *Information technology – Document description and processing languages – Office Open XML File Formats*

INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Field device integration (FDI) –
Part 6: Technology Mapping**

**Intégration des appareils de terrain (FDI) –
Partie 6: Mapping de technologies**

CONTENTS

FOREWORD	4
INTRODUCTION	6
1 Scope	7
2 Normative references	7
3 Terms, definitions, abbreviated terms, symbols and conventions	7
3.1 Terms and definitions	7
3.2 Abbreviated terms	8
3.3 Symbols	8
3.4 Conventions	8
4 Technical concepts	8
4.1 General	8
4.1.1 Overview	8
4.1.2 Platforms	9
4.1.3 FDI Type Library	9
4.2 UIP representation	10
4.3 UIP executable representation	11
4.4 UIP executable compatibility rules	11
4.5 Allowed .NET Common Language Run-time versions	11
4.5.1 General	11
4.5.2 CLR compatibility strategy	11
4.5.3 How to identify the .NET target platform of a UIP	12
4.6 UIP Deployment	12
4.7 UIP Lifecycle	13
4.7.1 General	13
4.7.2 UIP Assembly activation steps	13
4.7.3 UIP Assembly deactivation steps	15
4.8 Interaction between an FDI Client and a UIP	16
4.8.1 Handling of standard UI elements	16
4.8.2 Non-blocking service execution	16
4.8.3 Blocking service execution	17
4.8.4 Cancel service execution	18
4.8.5 Threading	19
4.8.6 Timeout	19
4.8.7 Exception handling	20
4.8.8 Type safe interfaces	21
4.8.9 Globalization and localization	21
4.8.10 WPF Control handling	21
4.8.11 Win Form handling	21
4.9 Security	21
4.9.1 General	21
4.9.2 Access permissions	22
4.9.3 Code identity concept	22
5 Interface definition	23
Figure 1 – FDI Type Library structure	10

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SOMMAIRE

AVANT-PROPOS	30
INTRODUCTION	32
1 Domaine d'application	33
2 Références normatives	33
3 Termes, définitions, termes abrégés, symboles et conventions	33
3.1 Termes et définitions	33
3.2 Termes abrégés	34
3.3 Symboles	34
3.4 Conventions	34
4 Concepts techniques	34
4.1 Généralités	34
4.1.1 Vue d'ensemble	34
4.1.2 Plates-formes	34
4.1.3 Bibliothèque de Types FDI	35
4.2 Représentation de l'UIP	36
4.3 Représentation de l'exécutable de l'UIP	36
4.4 Règles de compatibilité de l'exécutable de l'UIP	37
4.5 Versions permises du CLR (Common Language Run-time) .NET	37
4.5.1 Généralités	37
4.5.2 Stratégie de compatibilité CLR	37
4.5.3 Comment identifier la plate-forme cible .NET d'un UIP	38
4.6 Déploiement de l'UIP	38
4.7 Cycle de vie de l'UIP	39
4.7.1 Généralités	39
4.7.2 Étapes d'activation de l'Assemblage UIP	39
4.7.3 Étapes de désactivation de l'Assemblage UIP	41
4.8 Interaction entre un Client FDI et un UIP	42
4.8.1 Traitement des éléments normalisés de l'Interface Utilisateur	42
4.8.2 Exécution d'un service sans blocage	42
4.8.3 Exécution d'un service de blocage	43
4.8.4 Exécution du service Cancel	43
4.8.5 Threading (enfilage)	44
4.8.6 Expiration de délai	45
4.8.7 Traitement des exceptions	45
4.8.8 Interfaces de type sûr (type safe)	46
4.8.9 Globalisation et localisation	46
4.8.10 Traitement de contrôle WPF	47
4.8.11 Traitement des formes de Windows	47
4.9 Sécurité	47
4.9.1 Généralités	47
4.9.2 Permissions d'accès	47
4.9.3 Concept d'identité de code	48
5 Définition d'interface	48
Figure 1 – Structure de la Bibliothèque de Types FDI	36

Figure 2 – Processus de substitution .NET.....	38
Figure 3 – Identification de la version exécutable.....	38
Figure 4 – Exemple d'exécution d'un service asynchrone fondé sur IAsyncPattern.....	43
Figure 5 – Exemple d'exécution d'un service de blocage avec le modèle fondé sur IAsyncResult.....	43
Figure 6 – Exemple de séquence de traitement du service "Cancel"	44
Figure 7 – Source d'exception.....	46
Tableau 1 – Référence de l'édition de technologie	35
Tableau 2 – Services de Propriété de Base	49
Tableau 3 – Services de Modèle d'Appareil.....	49
Tableau 4 – Services de Contrôle d'Accès	49
Tableau 5 – Services d'Accès Direct	49
Tableau 6 – Services d'Hébergement.....	50
Tableau 7 – Services d'UIP	51
Tableau 8 – Types de données de base.....	52
Tableau 9 – Types particuliers	52

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Partie 6: Mapping de technologies

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Cette deuxième édition annule et remplace la première édition parue en 2015. Cette édition constitue une révision technique.

Cette édition inclut les modifications techniques majeures suivantes par rapport à l'édition précédente:

- a) redéfinition du concept de sécurité pour l'exécution de l'UIP.

Le texte de cette Norme internationale est issu des documents suivants:

FDIS	Rapport de vote
65E/763/FDIS	65E/773/RVD

Le rapport de vote indiqué dans le tableau ci-dessus donne toute information sur le vote ayant abouti à l'approbation de cette Norme internationale.

Ce document a été rédigé selon les Directives ISO/IEC, Partie 2.

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INTRODUCTION

La série IEC 62769 est publiée sous le titre général "*Intégration des appareils de terrain (FDI)*" et comporte les parties suivantes:

- Partie 1: Vue d'ensemble
- Partie 2: Client FDI
- Partie 3: Serveur FDI
- Partie 4: Paquetages FDI
- Partie 5: Modèle d'Information FDI
- Partie 6: Mapping de technologies FDI
- Partie 7: Appareils de Communication FDI
- Partie 100: Profils – Extensions de protocoles génériques
- Partie 101-1: Profils – Foundation Fieldbus H1
- Partie 101-2: Profils – Foundation Fieldbus HSE
- Partie 103-1: Profils – PROFIBUS
- Partie 103-4: Profils – PROFINET
- Partie 109-1: Profils – HART et WirelessHART
- Partie 115-2: Profils – Définitions spécifiques au protocole pour Modbus-RTU
- Partie 150-1: Profils – ISA 100.11a

INTÉGRATION DES APPAREILS DE TERRAIN (FDI) –

Partie 6: Mapping de technologies

1 Domaine d'application

La présente partie de l'IEC 62769 spécifie le mapping de technologies pour les concepts décrits dans la norme d'intégration des appareils de terrain (FDI). Le mapping de technologies porte essentiellement sur la mise en œuvre relative aux composants: Client FDI et Plugiciel d'Interface Utilisateur (UIP) qui ne sont spécifiques qu'à la plate-forme WORKSTATION (Poste de travail)/.NET telle que définie dans l'IEC 62769-4.

2 Références normatives

Les documents ci-après, dans leur intégralité ou non, sont des références normatives indispensables à l'application du présent document. Pour les références datées, seule l'édition citée s'applique. Pour les références non datées, la dernière édition du document de référence s'applique (y compris les éventuels amendements).

IEC 61804 (toutes les parties), *Blocs fonctionnels (FB) pour les procédés industriels et le Langage de Description Electronique de Produit (EDDL)*

IEC 62769-1, *Intégration des appareils de terrain (FDI) – Partie 1: Vue d'ensemble*

IEC 62769-2, *Intégration des appareils de terrain (FDI) – Partie 2: Client FDI*

IEC 62769-4, *Intégration des appareils de terrain (FDI) – Partie 4: Paquetages FDI*

IEC 62541 (toutes les parties), *Architecture unifiée OPC*

ISO/IEC 19505-1, *Information technology – Object Management Group Unified Modeling Language (OMG UML) – Part 1: Infrastructure* (disponible en anglais seulement)

ISO/IEC 29500 (toutes les parties), *Information technology – Document description and processing languages – Office Open XML File Formats* (disponible en anglais seulement)